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Fairchild Semiconductor FCH76N60NF

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November 2013

FCH76N60NF

N-Channel SupreMOS[®] FRFET[®] MOSFET 600 V, 72.8 A, 38 m Ω

Features

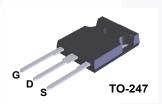
- $R_{DS(on)}$ = 28.7 m Ω (Typ.) @ V_{GS} = 10 V, I_D = 38 A
- Ultra Low Gate Charge (Typ. Q_q = 230 nC)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 896 pF)
- · 100% Avalanche Tested
- · RoHS Compliant

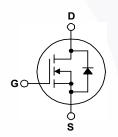
Application

- · Solar Inverter
- AC-DC Power Supply

Description

The SupreMOS® MOSFET is Fairchild Semiconductor's next generation of high voltage super-junction (SJ) technology employing a deep trench filling process that differentiates it from the conventional SJ MOSFETs. This advanced technology and precise process control provides lowest Rsp on-resistance, superior switching performance and ruggedness. SupreMOS MOSFET is suitable for high frequency switching power converter applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications. SupreMOS FRFET® MOSFET's optimized body diode reverse recovery performance can remove additional component and improve system reliability.





MOSFET Maximum Ratings $T_C = 25^{\circ}C$ unless otherwise noted.

Symbol		Parameter	FCH76N60NF	Unit
V _{DSS}	Drain to Source Voltage		600	V
V _{GSS}	Gate to Source Voltage		±30	V
1	Drain Current	- Continuous (T _C = 25°C)	72.8	A
ID	Dialii Cuitelli	- Continuous (T _C = 100°C)	46	_ A
I _{DM}	Drain Current	- Pulsed (Note	1) 218	Α
E _{AS}	Single Pulsed Avalanche Er	nergy (Note	2) 7381	mJ
I _{AR}	Avalanche Current	(Note	1) 24.3	Α
E _{AR}	Repetitive Avalanche Energy (Note 1)		1) 5.43	mJ
dv/dt	MOSFET dv/dt		100	V/ns
uv/ul	Peak Diode Recovery dv/dt	(Note	3) 50	V/IIS
D	Dower Dissinction	(T _C = 25°C)	543	W
P _D Power Dissipation		- Derate above 25°C	4.34	W/°C
T _J , T _{STG}	Operating and Storage Tem	perature Range	-55 to +150	οС
T _L	Maximum Lead Temperatur	e for Soldering, 1/8" from Case for 5 Seconds	300	°C

Thermal Characteristics

Symbol	Parameter	FCH76N60NF	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.23	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	40	



Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FCH76N60NF	FCH76N60NF	TO-247	Tube	N/A	N/A	30 units

Electrical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted.

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Charac	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 1 \text{ mA}, V_{GS} = 0 \text{ V}, T_C = 25^{\circ}\text{C}$	600	-	-	V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	I _D = 1 mA, Referenced to 25°C	-	0.73	-	V/°C
1	Zero Gate Voltage Drain Current	V _{DS} = 480 V, V _{GS} = 0 V	-	-	10	μА
IDSS	Zero Gate Voltage Drain Current	$V_{DS} = 480 \text{ V}, V_{GS} = 0 \text{ V}, T_{C} = 125^{\circ}\text{C}$	-	-	100	μΑ
I _{GSS}	Gate to Body Leakage Current	V _{GS} = ±30 V, V _{DS} = 0 V	-	-	±100	nA

On Characteristics

V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu\text{A}$	3.0	-	5.0	V
R _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 38 A	-	28.7	38.0	mΩ
9 _{FS}	Forward Transconductance	V _{DS} = 20 V, I _D = 38 A	-	92	-	S

Dynamic Characteristics

C _{iss}	Input Capacitance	V - 400 V V - 0 V	-	8305	11045	pF
C _{oss}	Output Capacitance	V _{DS} = 100 V, V _{GS} = 0 V f = 1 MHz		361	480	pF
C _{rss}	Reverse Transfer Capacitance			3.3	5.0	pF
Coss	Output Capacitance	V_{DS} = 380 V, V_{GS} = 0V, f = 1 MHz	-	192	-	pF
C _{oss(eff.)}	Effective Output Capacitance	V _{DS} = 0 V to 380 V, V _{GS} = 0 V		896	-	pF
Q _{g(tot)}	Total Gate Charge at 10V	V _{DS} = 380 V, I _D = 38 A,	-	230	300	nC
Q_{gs}	Gate to Source Gate Charge	V _{GS} = 10 V	-	44	-	nC
Q _{gd}	Gate to Drain "Miller" Charge	(Note 4)	-	95	-	nC
ESR	Equivalent Series Resistance(G-S)	f = 1 MHz	-	1.2	-	Ω

Switching Characteristics

t _{d(on)}	Turn-On Delay Time		-	51	112	ns
t _r	Turn-On Rise Time	$V_{DD} = 380 \text{ V}, I_D = 38 \text{ A}$	-/	44	98	ns
t _{d(off)}	Turn-Off Delay Time	$R_G = 4.7 \Omega$	-	213	436	ns
t _f	Turn-Off Fall Time	(Note 4)	_	43	96	ns

Drain-Source Diode Characteristics

Is	Maximum Continuous Drain to Source Diode Forward Current			-	76	Α
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	228	Α
V_{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0 V, I _{SD} = 38 A	-	-	1.2	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _{SD} = 38 A	-	200	-	ns
Q _{rr}	Reverse Recovery Charge	dI _F /dt = 100 A/μs	-	1.8	-	μC

Notes:

- Repetitive rating: pulse-width limited by maximum junction temperature.
- 2. I $_{AS}$ = 24.3 A, R $_{G}$ = 25 Ω , starting T $_{J}$ = 25°C.
- 3. I $_{SD} \leq 72.8$ A, di/dt ≤ 1200 A/µs, V $_{DD} \leq 380$ V, starting T $_{J}$ = 25°C.
- 4. Essentially independent of operating temperature typical characteristics.



Typical Performance Characteristics

Figure 1. On-Region Characteristics

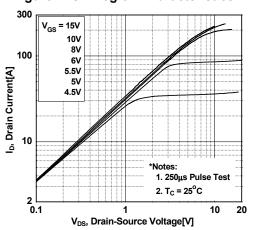


Figure 3. On-Resistance Variation vs. **Drain Current and Gate Voltage**

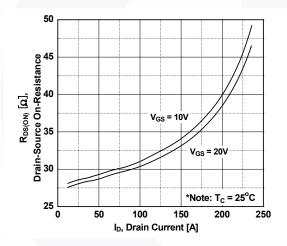


Figure 5. Capacitance Characteristics

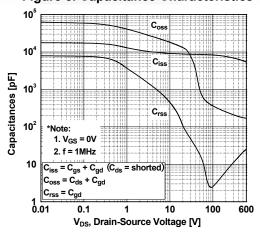


Figure 2. Transfer Characteristics

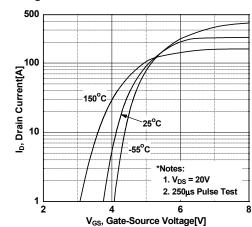


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

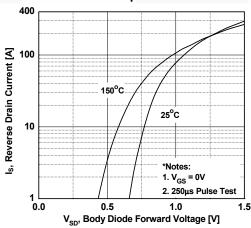
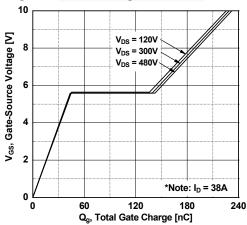


Figure 6. Gate Charge Characteristics





Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

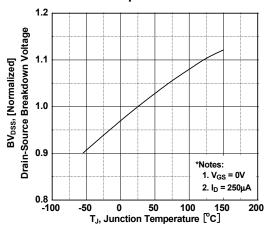


Figure 8. On-Resistance Variation vs. Temperature

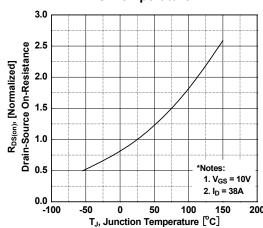


Figure 9. Maximum Safe Operating Area

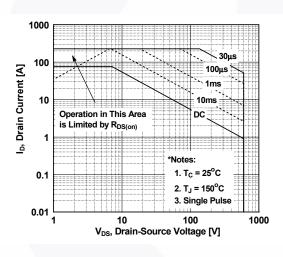


Figure 10. Maximum Drain Current vs. Case Temperature

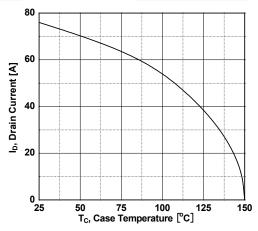
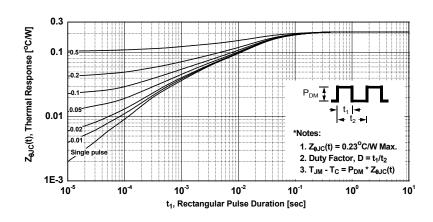


Figure 11. Transient Thermal Response Curve



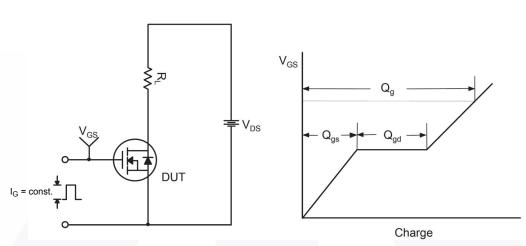


Figure 12. Gate Charge Test Circuit & Waveform

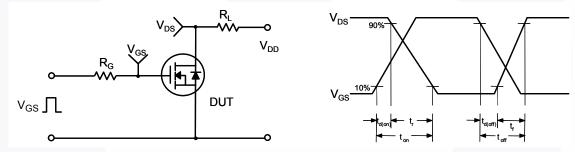


Figure 13. Resistive Switching Test Circuit & Waveforms

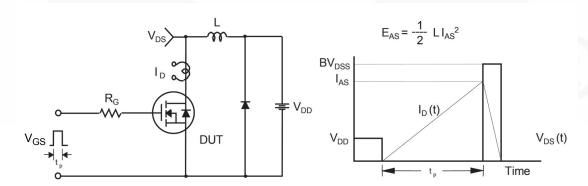
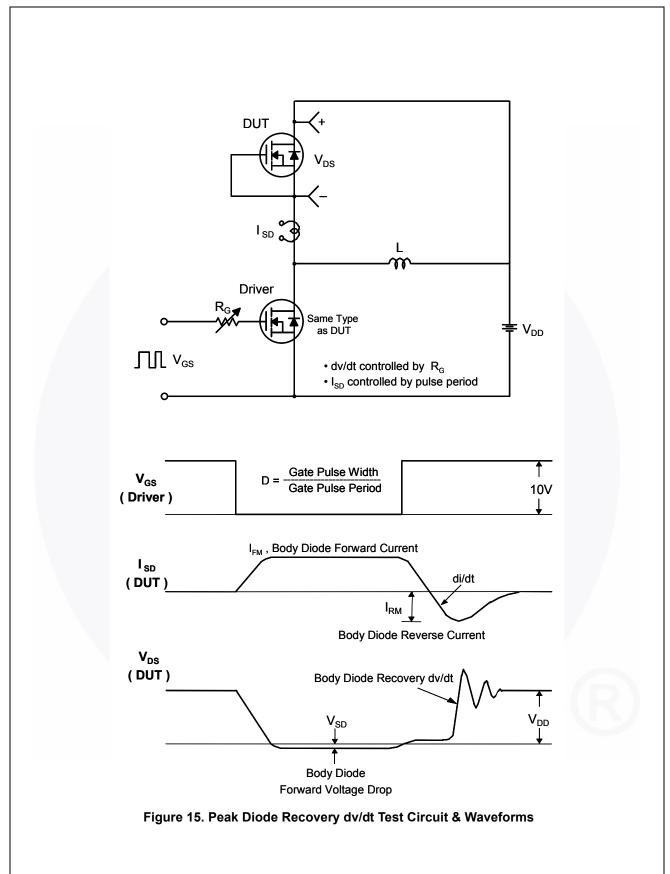


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms





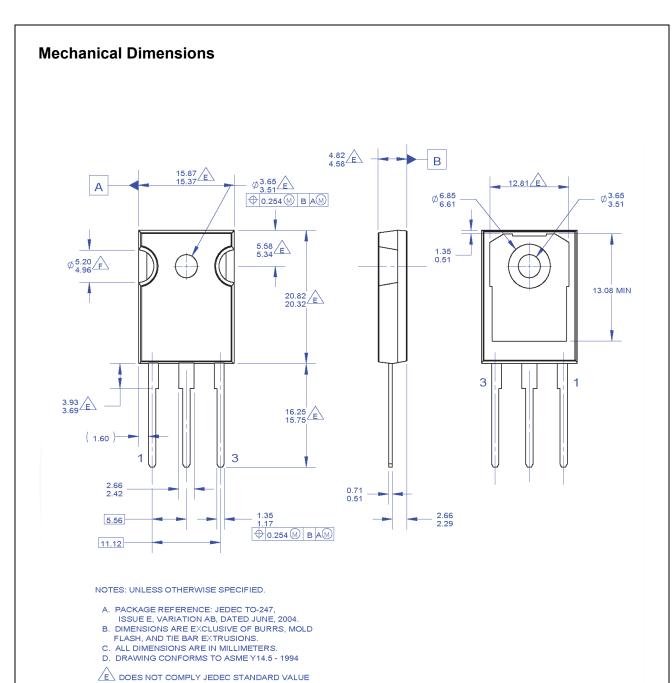


Figure 16. TO-247, Molded, 3-Lead, Jedec Variation AB

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